Preliminary

New relay, production not started,
engineering samples available

FUJITSU

POWER RELAY
1 POLE - 10A Slim Type Relay
FTR-F3 Series

■ FEATURES

- High density mounting
  Slim type with 7mm width and 142mm^2 mounting space
- High insulation
  Insulation distance: minimum 6mm between coil and contact
  (conforms to IEC 60065)
  Dielectric strength: 4KV
  Surge strength: 10KV
- Cadmium free contact for eco-program
- RoHS compliant
  Please see page 5 for more information

■ PARTNUMBER INFORMATION

[Example] FTR-F3 (a) A (b) A (c) 012 (d) E (e) - HC (f)

(a)	Relay type	FTR-F3	:FTR-F3-Series
(b)	Contact configuration	A	: 1 form A (SPST-NO)
(c)	Coil type (power)	A	: 200mW
(d)	Coil rated voltage	012	: 5.....24 VDC Coil rating table at page 3
(e)	Contact material	E	: AgNi
(f)	Enclosure	HC HK	: Flux proof type : Sealed type

Actual marking does not carry the type name : "FTR"
E.g.: Ordering code: FTR-F3AA012E Actual marking: F3AA012E

■ SPECIFICATION

Item			FTR-F3	
			FTR-F3AA( )E-HC	FTR-F3AA( )E-HK
Contact Data	Configuration		1 form A (SPST-NO)	
	Construction		Single	
	Material		AgNi	
	Resistance (initial)		Max. 100mOhm at 1A, 6VDC	
	Contact rating (resistive)		10A, 250VAC, 30VDC	
	Max. carrying current		10A	
	Max. switching voltage		277VAC, 30VDC	
	Max. switching power		2,500VA, 150W	
	Min. switching load *		100 mA, 5VDC	
Life	Mechanical		Min. 5 x 10^6 operations	
	Electrical (at rated load)		Min. 50 x 10^3 operations	Min. 10 x 10^3 operations
Coil Data	Rated power (20 °C)		200mW	
	Operate power		113mW	
	Operating temperature range		-40 °C to +85 °C (no frost)	
Timing Data	Operate (at nominal voltage)		Max. 10ms (without bounce, no diode)	
	Release (at nominal voltage)		Max. 10ms (without bounce, no diode)	
Insulation	Resistance (initial)		Min. 1,000MOhm at 500VDC	
	Dielectric strength	Open contacts	750VAC (50/60Hz) 1min	
		Contacts to coil	4,000VAC (50/60Hz) 1min	
	Surge strength	Contacts to coil	10,000V / 1.2 x 50µs standard wave	
	Clearance		6mm	
	Creepage		6mm	
	EN61810-1, VDE0435	Voltage	250V	
		Pollution degree	2	
		Material group	III	
Other	Vibration resistance	Misoperation	10 to 55Hz double amplitude 1.5mm	
		Endurance	10 to 55Hz double amplitude 1.5mm	
	Shock	Misoperation	Min. 100m/s^2 (11±1ms)	
		Endurance	Min. 1,000m/s^2 (6±1ms)	
	Weight		Approximately 4g	
	Enclosure		Flux proof	Plastic sealed

* Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

■ COIL RATING

200mW type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Max. Coil Voltage (VDC)	Rated Power (mW)
005	5	125	3.75	0.5	12	200
006	6	180	4.5	0.6	14.4	
009	9	405	6.75	0.9	21.6	
012	12	720	9	1.2	28.8	
018	18	1,620	13.5	1.8	43.2	
024	24	2,880	18	2.4	57.6	

Note: All values in the tables are valid for 20°C and zero contact current.
* Specified operate values are valid for pulse wave voltage.

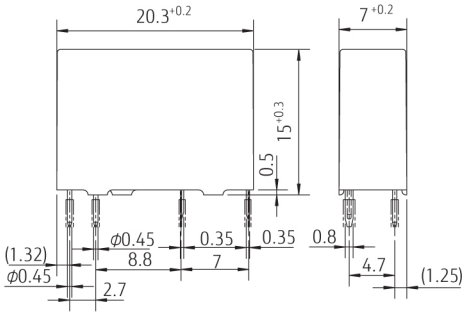
■ SAFETY STANDARDS (Plan)

Type	**Compliance**	**Contact rating**	
		FTR-F3AA( )E-HC	FTR-F3AA( )E-HK
UL	UL 508 E63614	Flammability: UL 94-V0 (plastics)	
		10A, 30 VDC/ 277 VAC (resistive)	10A, 30 VDC/ 277 VAC (resistive)
CSA	C22.2 No. 14 LR 40304		
VDE	0435 40015024	10A, 250 VAC, cosφ =1, 50 x 10^3, 85°C 8A, 30 VDC, τ=0msec, 50 x 10^3, 105°C	10A, 250 VAC, cosφ =1, 10 x 10^3, 85°C 8A, 30 VDC, τ=0msec, 50 x 10^3, 105°C

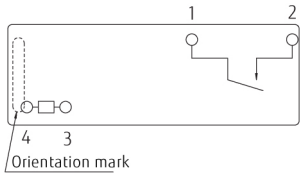
■ DIMENSIONS

Standard type

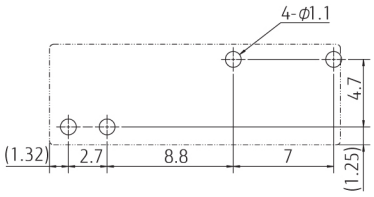
- **Dimensions**



- **Schematics**
(BOTTOM VIEW)



- **PC board mounting hole layout**
(BOTTOM VIEW)



Unit: mm

RoHS Compliance and Lead Free Information

1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives.
  As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at:
  http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified.
  This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Condition

- Recommended solder Sn-3.0Ag-0.5Cu.

Flow Solder Condition:

Pre-heating:	maximum 120˚C within 90 sec.
Soldering:	dip within 5 sec. at 255˚C ± 5˚C solder bath

Relay must be cooled by air immediately after soldering

Solder by Soldering Iron:

Soldering Iron Temperature:	30-60W maximum 350-360˚C
Duration:	maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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